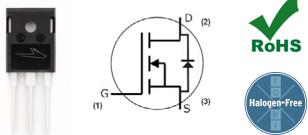


# C3M0045065D

# Silicon Carbide Power MOSFET C3M<sup>™</sup> MOSFET Technology N-Channel Enhancement Mode

### Features

- 3<sup>rd</sup> Generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- Halogen free, RoHS compliant



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Ordering Part Number	Package	Marking
C3M0045065D	TO 247-3	C3M0045065D

### **Typical Applications**

- EV chargers
- Server & Telecom PSU
- UPS
- Solar inverters
- SMPS
- DC/DC converters

#### Benefits

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

### **Key Parameters**

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V <sub>DS</sub>			650	v	T <sub>c</sub> = 25°C	
Maximum Gate - Source Voltage	V <sub>GS(max)</sub>	-8		+19		Transient	
Operational Gate-Source Voltage	V <sub>GS op</sub>		-4/15			Static	Note 1
DC Continuous Drain Current	I <sub>D</sub>			49	A	$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 25 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	Fig. 19 Note 2
				35		V <sub>GS</sub> = 15 V, T <sub>C</sub> = 100 °C, T <sub>J</sub> ≤175 °C	
Pulsed Drain Current	I <sub>DM</sub>			132		$t_{Pmax}$ limited by $T_{jmax}$ $V_{GS} = 15V, T_{C} = 25 °C$	Fig. 22
Power Dissipation	P <sub>D</sub>			176	w	T <sub>c</sub> = 25°C, T <sub>J</sub> = 175 °C	Fig. 20
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>			-40 to +175	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M <sub>D</sub>			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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# **Electrical Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
		1.8	2.6	3.6		$V_{DS} = V_{GS, I_D} = 4.84 \text{ mA}$	— Fig. 11	
Gate Threshold Voltage	V <sub>GS(th)</sub>	_	2.2	_	V	$V_{DS} = V_{GS, I_D} = 4.84 \text{ mA, } T_J = 175^{\circ}C$		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I <sub>GSS</sub>	_	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	P	_	45	60	mΩ	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 17.6 \text{ A}$	Fig.	
	R <sub>DS(on)</sub>	_	60	_	11122	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 17.6 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	4, 5, 6	
Transconductance			12		S	$V_{GS} = 20 \text{ V}, I_D = 17.6 \text{ A}$	<b>F</b> :- 7	
Transconductance	g <sub>fs</sub>		11 -		3	$V_{GS} = 20 \text{ V}, \text{ I}_{D} = 17.6 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	- Fig. 7	
Input Capacitance	C <sub>iss</sub>	_	1621	_		$V_{GS} = 0 V, V_{DS} = 600 V$	Fig. 17, 18	
Output Capacitance	C <sub>oss</sub>	_	101	_		<i>f</i> = 1 Mhz		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	8	_	pF	V <sub>AC</sub> = 25 mV		
Effective Output Capacitance (Energy Related) <sup>1</sup>	C <sub>o(er)</sub>	_	126	_			Note 3	
Effective Output Capacitance (Time Related) <sup>1</sup>	C <sub>o(tr)</sub>	_	178	_		$V_{GS} = 0 V, V_{DS} = 0V \text{ to } 400 V$		
C <sub>oss</sub> Stored Energy	E <sub>oss</sub>	_	20	_			Fig. 16	
Turn-On Switching Energy (Body Diode)	Eon	_	210	_		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 17.6 \text{ A},$	– Fig. 25	
Turn Off Switching Energy (Body Diode)	E <sub>off</sub>	_	42	_	μJ	$R_{G(ext)} = 2.5 \Omega$ , L= 99 $\mu$ H, T <sub>J</sub> = 175°C FWD = Internal Body Diode of MOSFET		
Turn-On Switching Energy (External Sic Diode)	E <sub>on</sub>	_	161	_		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 17.6 \text{ A},$		
Turn Off Switching Energy (External Sic Diode)	E <sub>off</sub>	_	42	_		$R_{G(ext)} = 2.5 \Omega$ , L= 99 µH, T <sub>J</sub> = 175°C FWD = External SiC DIODE		
Turn-On Delay Time	t <sub>d(on)</sub>	_	10	_		V <sub>DD</sub> = 400 V, V <sub>GS</sub> = -4 V/15 V	Fig. 26	
Rise Time	tr	_	32	_		$I_{D} = 17.6 \text{ A}, R_{G(ext)} = 2.5 \Omega,$		
Turn-Off Delay Time	t <sub>d(off)</sub>	_	20	_	ns	L= 99 μH Timing relative to V <sub>DS</sub>		
Fall Time	t <sub>f</sub>	_	8	_		Inductive load		
Internal Gate Resistance	R <sub>G(int)</sub>	_	3	_	Ω	<i>f</i> = 1 MHz, V <sub>AC</sub> = 25 mV		
Gate to Source Charge	Q <sub>gs</sub>	_	_	_	-			
Gate to Drain Charge	Q <sub>gd</sub>	_	20	_	nC	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = -4 V/15 V I <sub>D</sub> = 17.6 A	Fig. 12	
Total Gate Charge	Qg	_	63	_	Per IEC60747-8-4 pg 21			

Note:

 $^{3}$  C<sub>o(er)</sub>, a lumped capacitance that gives same stored energy as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 400V C<sub>o(tr)</sub>, a lumped capacitance that gives same stored energy as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 400V

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# **Reverse Diode Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Diode Forward Voltage		4.8	-	v	$V_{GS} = -4 V$ , $I_{SD} = 8.8 A$ , $T_{J} = 25^{\circ}C$	Fig.
	V <sub>SD</sub>	4.2	-		$V_{GS} = -4 V$ , $I_{SD} = 8.8 A$ , $T_{J} = 175^{\circ}C$	8,9,10
Continuous Diode Forward Current	Is	-	29		V <sub>GS</sub> = -4 V, T <sub>C</sub> = 25°C	
Diode pulse Current	I <sub>SM</sub>	_	132	A	$V_{GS}$ = -4 V, pulse width t <sub>P</sub> limited by $T_{jmax}$	
Reverse Recovery Time	t <sub>rr</sub>	26	-	ns		
Reverse Recovery Charge	Qrr	171	_	nC	$V_{GS} = -4 V, I_{SD} = 17.6 A, V_{R} = 400 V$ $di_{c}/dt = 1220 A/\mu s, T_{J} = 175^{\circ}C$	
Peak Reverse Recovery Current	I <sub>RRM</sub>	11	_	A		
Reverse Recovery Time	t <sub>rr</sub>	34	_	ns		
Reverse Recovery Charge	Qrr	156	-	nC	$V_{GS} = -4 V, I_{SD} = 17.6 A, V_{R} = 400 V$ $di_{z}/dt = 850 A/\mu s, T_{J} = 175^{\circ}C$	
Peak Reverse Recovery Current	I <sub>RRM</sub>	8	_	А		

### **Thermal Characteristics**

Parameter	Symbol	Тур.	Unit	Note
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.85	9C (M)	Fi- 21
Thermal Resistance From Junction to Ambient	R <sub>0JA</sub>	40	°C/W	Fig. 21



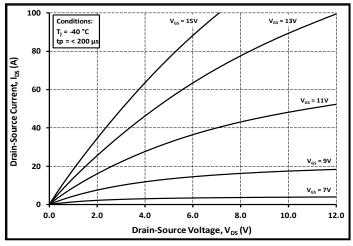
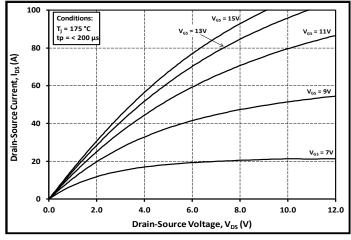
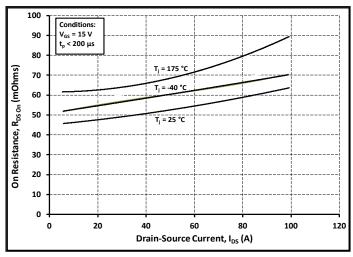
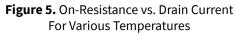


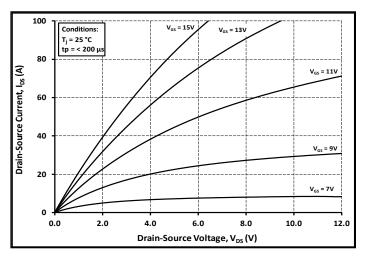
Figure 1. Output Characteristics T<sub>J</sub> = -40°C

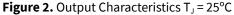












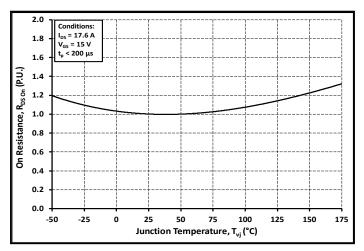


Figure 4. Normalized On-Resistance vs. Temperature

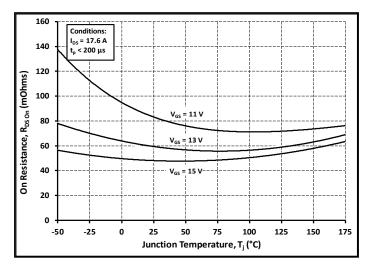
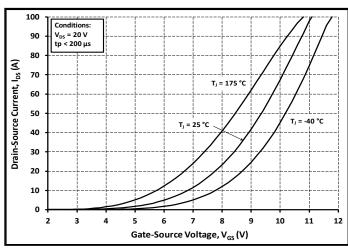


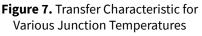
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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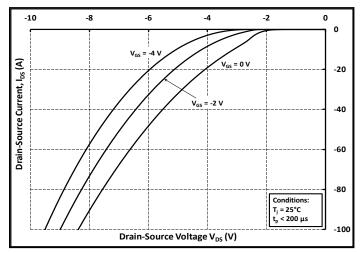


Figure 9. Body Diode Characteristic at 25°C

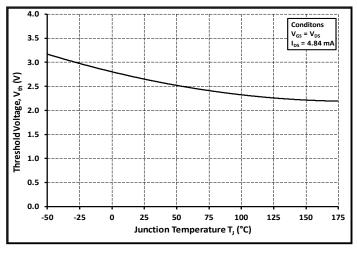


Figure 11. Threshold Voltage vs. Temperature

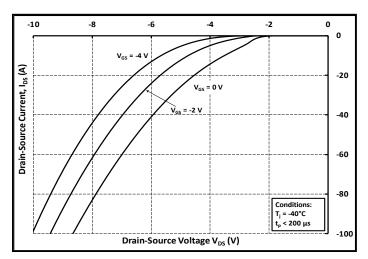


Figure 8. Body Diode Characteristic at -40°C

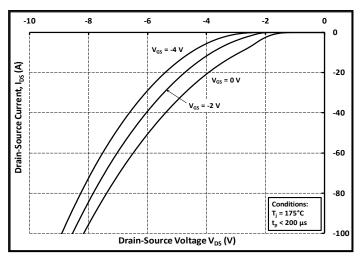
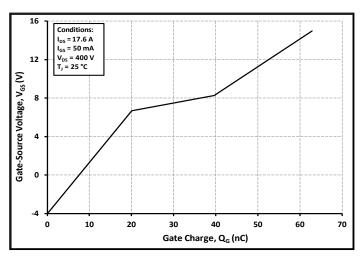


Figure 10. Body Diode Characteristic at 175°C





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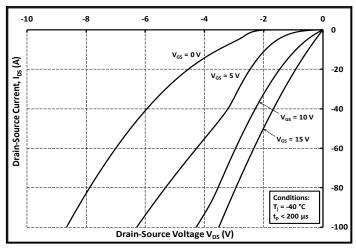


Figure 13. 3rd Quadrant Characteristic at -40°C

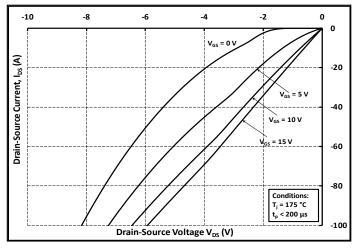
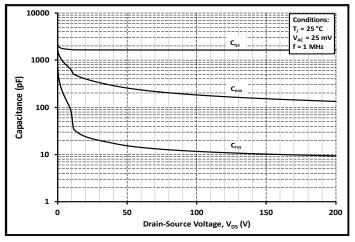
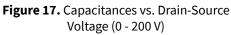


Figure 15. 3rd Quadrant Characteristic at 175°C





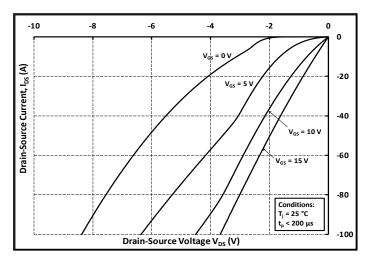


Figure 14. 3rd Quadrant Characteristic at 25°C

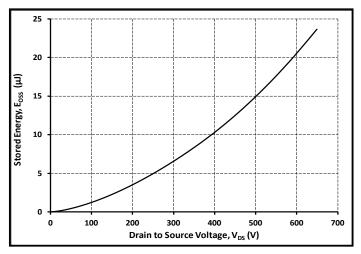


Figure 16. Output Capacitor Stored Energy

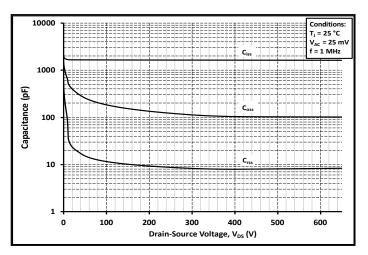
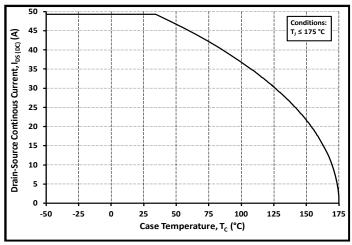


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650 V)

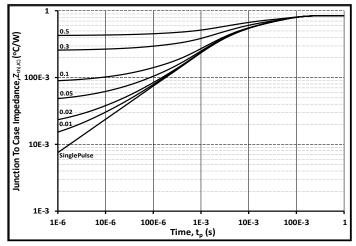
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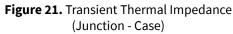
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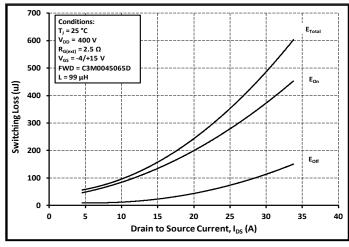


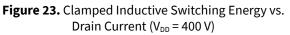












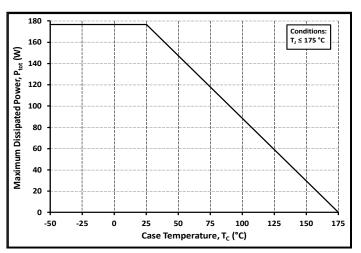


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

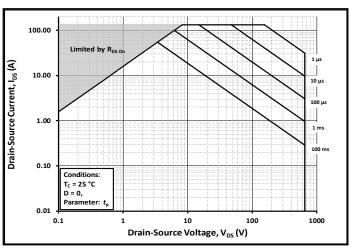


Figure 22. Safe Operating Area

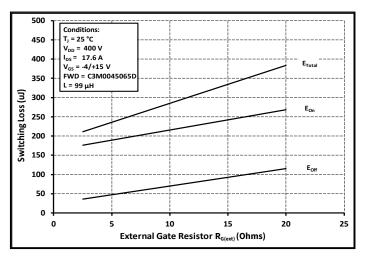


Figure 24. Clamped Inductive Switching Energy vs.  $\mathsf{R}_{\mathsf{G}(\mathsf{ext})}$ 

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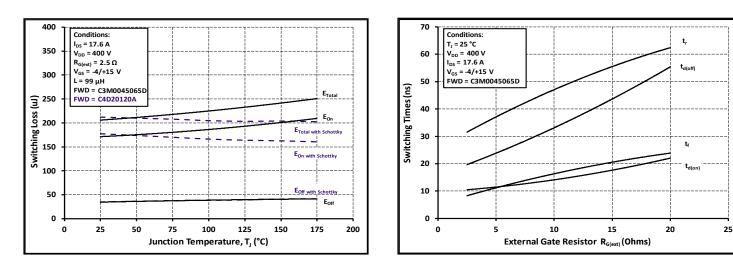


Figure 25. Clamped Inductive Switching Energy vs. Temperature



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### **Test Circuit Schematic**

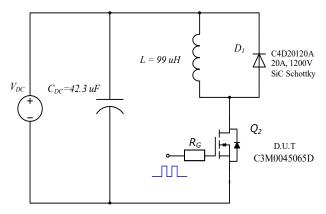


Figure 27. Clamped Inductive Switching Waveform Test Circuit

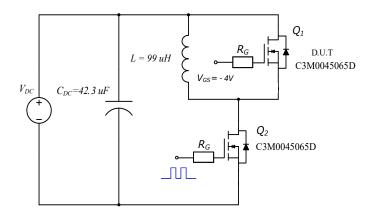
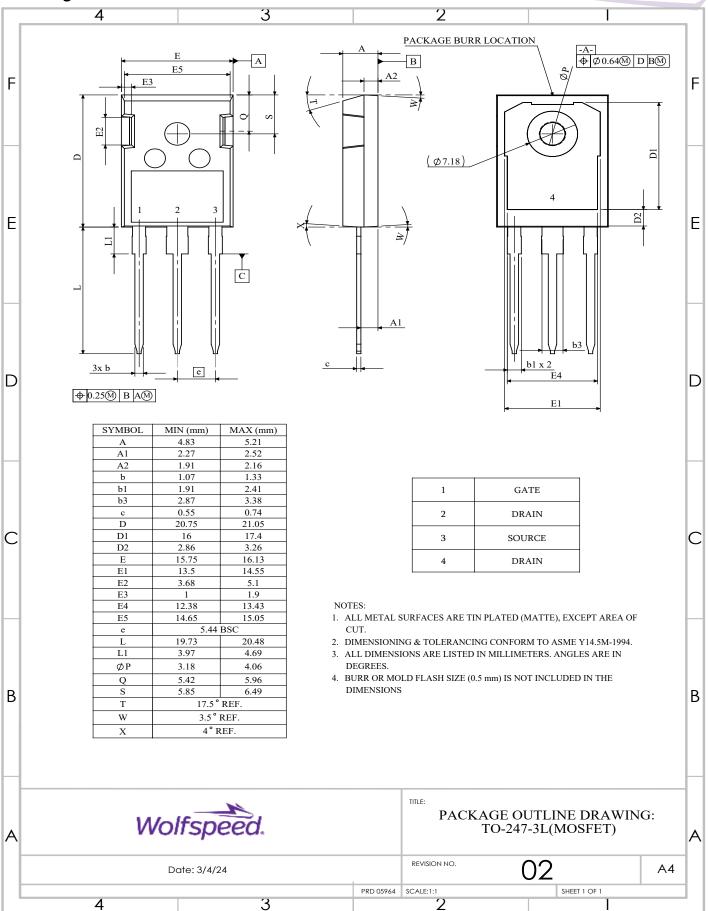


Figure 28. Body Diode Recovery Test Circuit

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### C3M0045065D

### Package Dimensions - TO-247-3



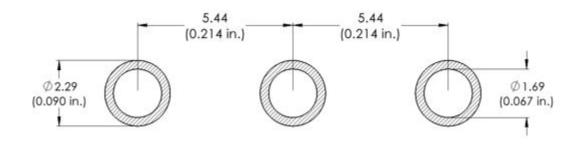
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# **Recommended Solder Pad Layout**



### **Revision History**

Current Revision	Date of Release	Description of Changes
1	December-2020	N/A
2	November-2023	Not Released
3	December-2023	Updated Wolfspeed branding, package drawing, package image, and solder pad layout, added Revision History Table, Revised Table 1 Layout
4	September - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

### **Related Links**

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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